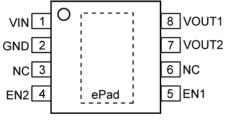
Ordering Information

Manufacturer Ordering Part Number	Part Number ⁽¹⁾	Marking Code	Voltage ⁽²⁾	Junction Temperature Range	Package
MIC5355-SGYMME	MIC5355-3.3/1.8YMME	55SG	3.3V/1.8V	–40° to +125°C	8-Pin ePad MSOP
MIC5355-S4YMME	MIC5355-3.3/1.2YMME	55S4	3.3V/1.2V	–40° to +125°C	8-Pin ePad MSOP
MIC5355-SCYMME	MIC5355-3.3/1.0YMME	55SC	3.3V/1.0V	–40° to +125°C	8-Pin ePad MSOP
MIC5355-G4YMME	MIC5355-1.8/1.2YMME	55G4	1.8V/1.2V	–40° to +125°C	8-Pin ePad MSOP
MIC5355-JGYMME	MIC5355-2.5/1.8YMME	55JG	2.5V1.8V	–40° to +125°C	8-Pin ePad MSOP
MIC5356-SGYMME	MIC5356-3.3/1.8YMME	56SG	3.3V/1.8V	–40° to +125°C	8-Pin ePad MSOP
MIC5356-S4YMME	MIC5356-3.3/1.2YMME	56S4	3.3V/1.2V	–40° to +125°C	8-Pin ePad MSOP
MIC5356-SCYMME	MIC5356-3.3/1.0YMME	56SC	3.3V/1.0V	–40° to +125°C	8-Pin ePad MSOP
MIC5356-G4YMME	MIC5356-1.8/1.2YMME	56G4	1.8V/1.2V	–40° to +125°C	8-Pin ePad MSOP
MIC5356-JGYMME	MIC5356-2.5/1.8YMME	56JG	2.5V/1.8V	–40° to +125°C	8-Pin ePad MSOP
MIC5356-MMYML	MI5356-2.8/2.8YML	МЗМ	2.8V/2.8V	-40° to +125°C	8-Pin ePad 3mm x 3mm MLF®
MIC5356-MGYML	MI5356-2.8/1.8YML	M3G	2.8V/1.8V	-40° to +125°C	8-Pin ePad 3mm x 3mm MLF®

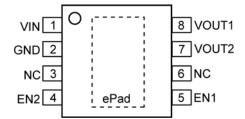
Notes:

- 1. MIC5356 offers Auto-Discharge function.
- 2. Other voltage available. Contact Micrel for detail.

Pin Configuration



8-Pin ePad MSOP (MME)



8-Pin ePad 3mm x 3mm MLF® (ML)

Pin Description

Pin Number	Pin Name	Pin Function
1	VIN	Supply Input.
2	GND	Ground.
3	NC	Not internally connected.
4	EN2	Enable Input LDO2. Active High Input. Logic High = On; Logic Low = Off; Do not leave floating.
5	EN1	Enable Input LDO1. Active High Input. Logic High = On; Logic Low = Off; Do not leave floating.
6	NC	Not internally connected.
7	VOUT2	LDO2 Output.
8	VOUT1	LDO1 Output.
ePad	HSPAD	Heatsink pad. Connect to ground.

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V _{IN})	0.3V to +6V
Enable Voltage (V _{EN1} , V _{EN2})	–0.3V to V_{IN} +0.3V
Power Dissipation (P _D)	Internally Limited ⁽³⁾
Lead Temperature (soldering, 10sec.)260°C
Junction Temperature (T _J)	40°C to +125°C
Storage Temperature (T _s) ESD Rating ⁽⁴⁾	–65°C to +150°C
ESD Rating ⁽⁴⁾	ESD Sensitive

Operating Ratings⁽²⁾

Supply Voltage (V _{IN})	+2.5V to 5.5V
Enable Voltage (V _{EN1} , V _{EN2})	0V to V _{IN}
Junction Temperature (T _J)	40°C to +125°C
Junction Thermal Resistance	
8-Pin ePad MSOP (θ _{JA})	64.4°C/W
8-Pin ePad 3mm x 3mm MLF®	(θ_{JA}) 61°C/W

Electrical Characteristics(5)

 $V_{IN} = V_{EN1} = V_{EN2} = V_{OUT} + 1V; \ higher \ of the \ two \ outputs; \ I_{OUTLDO1} = I_{OUTLDO2} = 100 \mu A; \ C_{OUT1} = C_{OUT2} = 2.2 \ \mu F; \ T_J = +25 ^{\circ}C, \ bold \ values \ indicate -40 ^{\circ}C \ to +125 ^{\circ}C, \ unless \ noted.$

Parameter	Condition	Min.	Тур.	Max.	Units
Output Voltage Accuracy	Variation from nominal V _{OUT}			+2.0	%
Output Voltage Accuracy	Variation from nominal V _{OUT}			+3.0	/0
Line Regulation	$V_{IN} = V_{OUT} + 1V \text{ to } 5.5V, I_{OUT} = 100 \mu\text{A}$		0.02	0.3	%/V
Load Regulation	I _{OUT} = 100μA to 500mA		0.3	1	%
Dropout Voltage	I _{OUT} = 50mA		40	100	mV
Diopout Voltage	I _{OUT} = 500mA		350	800	IIIV
	V _{EN1} = High; V _{EN2} = Low; I _{OUT1} = 0mA		38	53	
	V _{EN1} = Low; V _{EN2} = High; I _{OUT2} = 0mA		38	53	
Ground Pin Current	$V_{EN1} = V_{EN2} = High; I_{OUT1} = I_{OUT2} = 0mA$		70	100	
Glound Pin Current	V _{EN1} = High; V _{EN2} = Low; I _{OUT1} = 500mA		55	90	μA
	V_{EN1} = Low; V_{EN2} = High; I_{OUT2} = 500mA		55	90	
	$V_{EN1} = V_{EN2} = High; I_{OUT1} = I_{OUT2} = 500mA$		105	200	
Shutdown Current	V _{EN1} = V _{EN2} ≤0.2V		0.05	1	μA
Ripple Rejection	Ripple Rejection $f = 1kHz$; $C_{OUT} = 2.2\mu F$; $I_{OUT} = 250mA$		60		dB
Current Limit	V _{OUT} = 0V		750	1050	mA
Output Voltage Noise	C _{OUT} = 2.2μF, 10Hz to 100kHz		146		μV _{RMS}
Auto-Discharge NFET Resistance MIC5356 only; $V_{EN1} = V_{EN2} = 0V$; $V_{IN} = 3.6V$; $I_{OUT} = -3mA$			30		Ω

Notes:

- 1. Exceeding the absolute maximum rating may damage the device.
- 2. The device is not guaranteed to function outside its operating rating.
- The maximum allowable power dissipation of any T_A (ambient temperature) is P_{D(MAX)} = (T_{J(MAX)} T_A) / θ_{JA}. Exceeding the maximum allowable power dissipation will result in excessive die temperature and the register will go into thermal shutdown.
- 4. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5kΩ in series with 100pF.
- Specification for packaged product only.

Electrical Characteristics(4)

 $V_{IN} = V_{EN1} = V_{EN2} = V_{OUT} + 1V; \ higher \ of the \ two \ outputs; \ I_{OUTLDO1} = I_{OUTLDO2} = 100 \mu A; \ C_{OUT1} = C_{OUT2} = 2.2 \ \mu F; \ T_J = +25 ^{\circ}C, \ bold \ values \ indicate -40 ^{\circ}C \ to +125 ^{\circ}C, \ unless \ noted.$

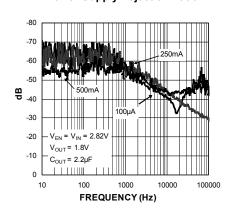
Parameter	Condition	Min.	Тур.	Max.	Units		
Enable Inputs (EN1/EN2)							
Enable Input Voltage	Logic Low			0.2	V		
	Logic High	1.2					
Enable Input Current	$V_{IL} \leq 0.2V$		0.01	1	μΑ		
	$V_{IH} \ge 1.2V$		0.01	1			
Turn-On Time			50	125	μs		

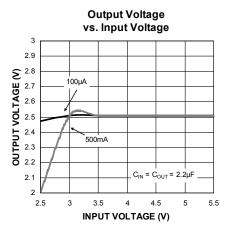
Notes:

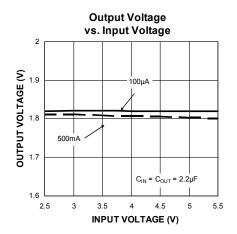
- 1. Exceeding the absolute maximum rating may damage the device.
- 2. The device is not guaranteed to function outside its operating rating.
- 3. Devices are ESD sensitive. Handling precautions recommended. Human body model, $1.5 k\Omega$ in series with 100 pF.
- 4. Specification for packaged product only.

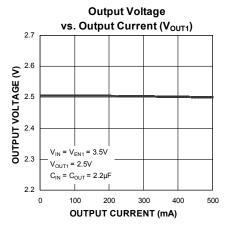
Typical Characteristics

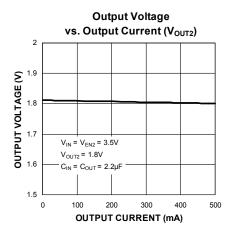
Power Supply Rejection Ratio

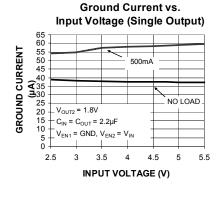


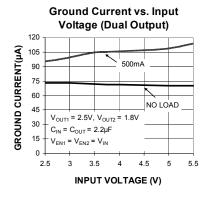


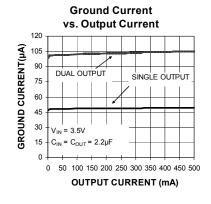


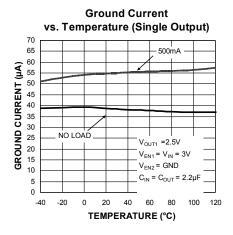




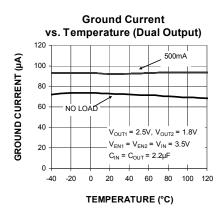


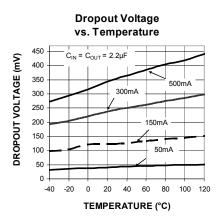


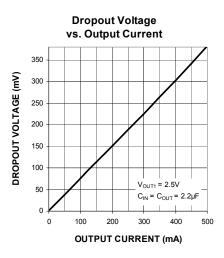


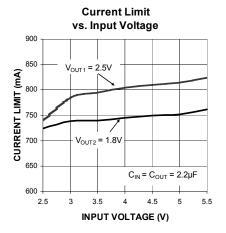


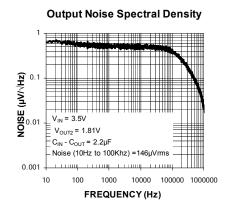
Typical Characteristics (Continued)



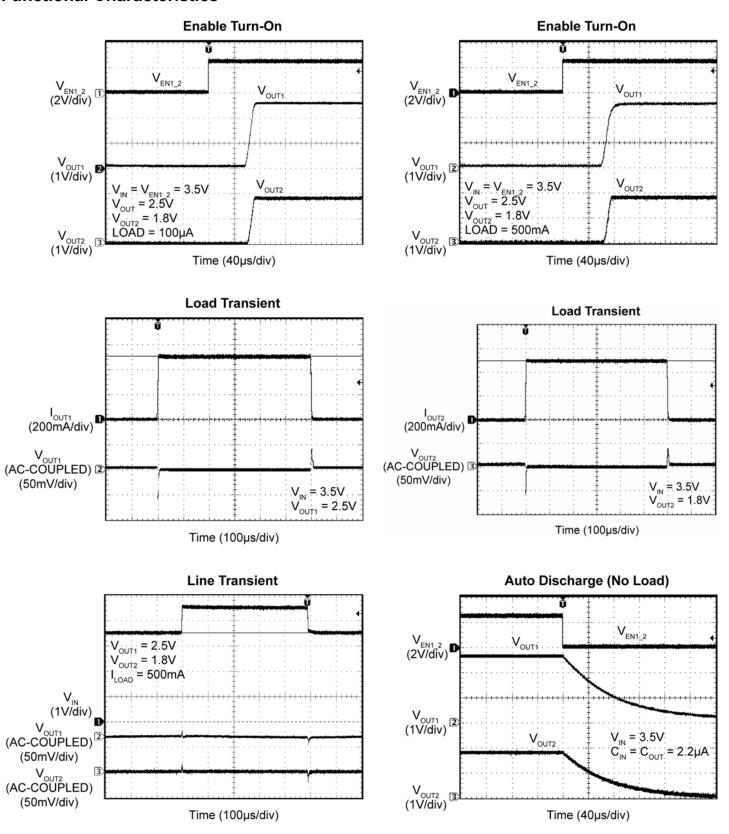




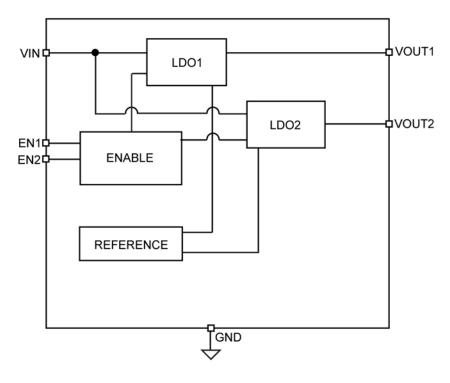




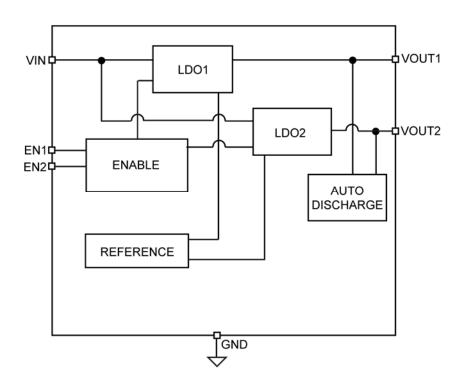
Functional Characteristics



Functional Diagrams



MIC5355 Block Diagram



MIC5356 Block Diagram

Application Information

MIC5355/6 is a dual 500mA LDO. The MIC5356 includes an auto-discharge circuit for each LDO output that is activated when the output is disabled. The MIC5355/6 regulator is fully protected from damage due to fault conditions through linear current limiting and thermal shutdown.

Input Capacitor

The MIC5355/6 is a high-performance, high-bandwidth device. A 2.2µF input capacitor from the input pin to ground is required to provide stability. Low-ESR ceramic capacitors provide optimal performance in small board area. Additional high-frequency capacitors, such as small valued NPO dielectric type capacitors, help filter out high-frequency noise and are good practice in any RF based circuit. X5R or X7R dielectrics are recommended for the input capacitor. Y5V dielectrics lose most of their capacitance over temperature and are therefore not recommended.

Output Capacitor

The MIC5355/6 requires an output capacitor of $2.2\mu F$ or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High-ESR capacitors may cause high-frequency oscillation. The output capacitor can be increased, but performance has been optimized for a $2.2\mu F$ ceramic output capacitor and does not improve significantly with larger capacitance.

X7R and X5R dielectric ceramic capacitors are recommended because of their temperature performance. X7R capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60% respectively over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

No Load Stability

Unlike many other voltage regulators, the MIC5355/6 will remain stable and in regulation with no load.

Enable/Shutdown

The MIC5355/6 comes with two active high enable pins that allow each regulator to be disabled independently. Forcing the enable pin low disables the regulator and places it into an off mode current state drawing virtually zero current. When disabled, the MIC5356 switches an internal 30Ω load on the regulator output to discharge the external capacitor.

Forcing the enable pin high enables the output voltage. The active high enable pin uses CMOS technology and cannot be left floating. A floating enable pin may cause an indeterminate state on the output.

Thermal Considerations

The MIC5355/6 is designed to provide two 500mA continuous current outputs in a small package. Maximum operating temperature can be calculated based on the output currents and the voltage drop across the part. For example, if the input voltage is 3.0V, $V_{\text{OUT1}} = 2.5 \text{V}$, $V_{\text{OUT2}} = 1.8 \text{V}$ and each with an output current = 500mA. The actual power dissipation of the regulator circuit can be determined using the equation:

$$P_D = (V_{IN} - V_{OUT1}) I_{OUT} + (V_{IN} - V_{OUT2}) I_{OUT2} + V_{IN} I_{GND}$$

Because this is CMOS device and the ground current is typically $<100\mu$ A over the load range, the power dissipation contributed by the ground current is <1% which can be ignored for this calculation:

$$P_D = (3.0V - 2.5V) \times 500mA + (3.0V - 1.8V) \times 500mA$$

 $P_D = 0.85W$

To determine the maximum ambient operating temperature of the package, use the junction to ambient thermal resistance of the device and the following basic equation:

$$P_{D(MAX)} = \left(\frac{T_{J(MAX)} - T_{A}}{\theta_{JA}}\right)$$

$$T_{J(MAX)} = 125^{\circ}C$$

 $\theta_{JA} = 64.4^{\circ}C/W$

Substituting P_D for $P_{D(MAX)}$ and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The junction to ambient thermal resistance for the minimum footprint is 64.4°C/W .

The maximum power dissipation must not be exceeded for proper operation.

For example, when operating a 2.5V/1.8V application with an input voltage of 3.0V and 500mA at each output with a minimum footprint layout, the maximum ambient operating temperature T_A can be determined as follows:

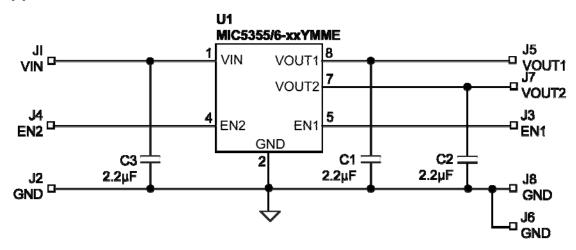
$$0.85W = (125^{\circ}C - T_A)/(64.4^{\circ}C/W)$$

 $T_A = 70.3^{\circ}C$

Therefore, a MIC5355-JGYMME application with 500mA at each output current can accept an ambient operating temperature of 70.3°C in a small 8-pin ePad MSOP package. For a full discussion of heat sinking and thermal effects on voltage regulators refer to the "Regulator Thermals" section of *Micrel's Designing with Low-Dropout Voltage Regulators* handbook. This information can be found on Micrel's website at:

http://www.micrel.com/ PDF/other/LDOBk ds.pdf

Typical Application Schematic



Bill of Materials

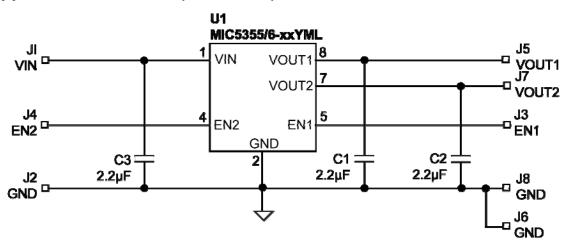
Item	Part Number	Manufacturer	Description	Qty.
C1, C2, C3	C1005X5R0J225M	TDK ⁽¹⁾	2.2µF ceramic capacitor, 6.3V, X5R, size 0402	3
U1	MIC5355/6-xxYMME	Micrel, Inc. ⁽²⁾	Dual 500mA μCap Low-Dropout, Micropower Linear Regulator	1

Notes:

1. TDK: www.tdk.com.

2. Micrel, Inc.: www.micrel.com.

Typical Application Schematic (Continued)



Bill of Materials

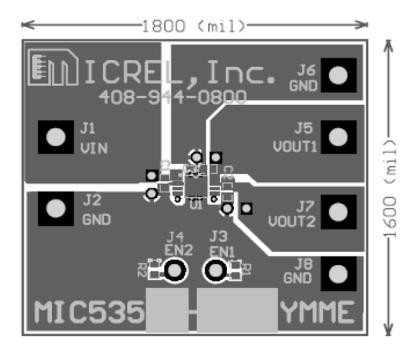
Item	Part Number	Manufacturer	Description	Qty.
C1, C2, C3	C1005X5R0J225M	TDK ⁽¹⁾	2.2µF ceramic capacitor, 6.3V, X5R, size 0402	3
U1	MIC5355/6-xxYML	Micrel, Inc. ⁽²⁾	Dual 500mA μCap Low-Dropout, Micropower Linear Regulator	1

Notes:

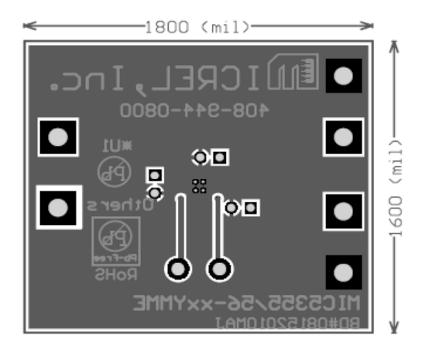
3. TDK: www.tdk.com.

4. Micrel, Inc.: www.micrel.com.

PCB Layout Recommendations (MME Package)

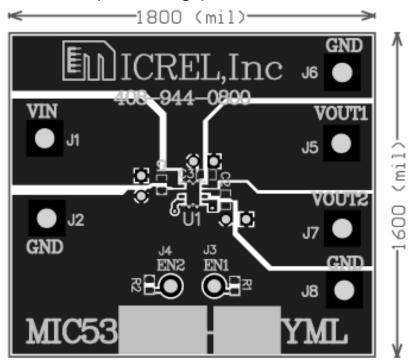


Top Layer

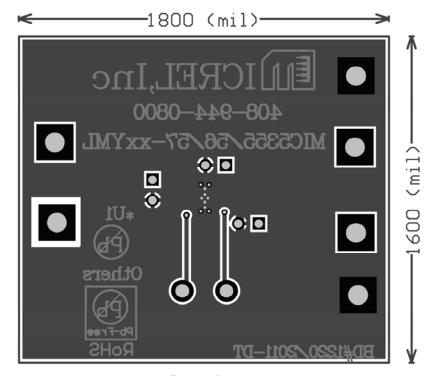


Bottom Layer

PCB Layout Recommendations (ML Package)

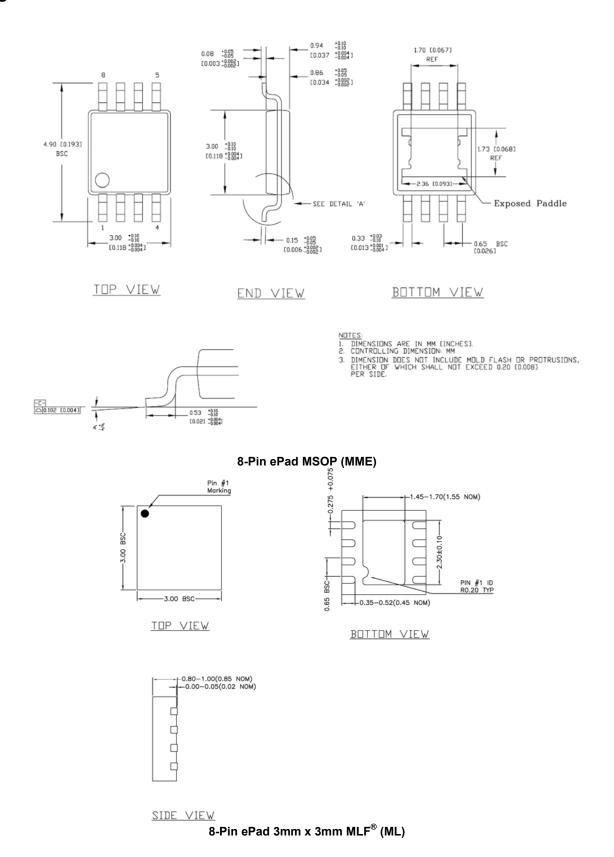


Top Layer



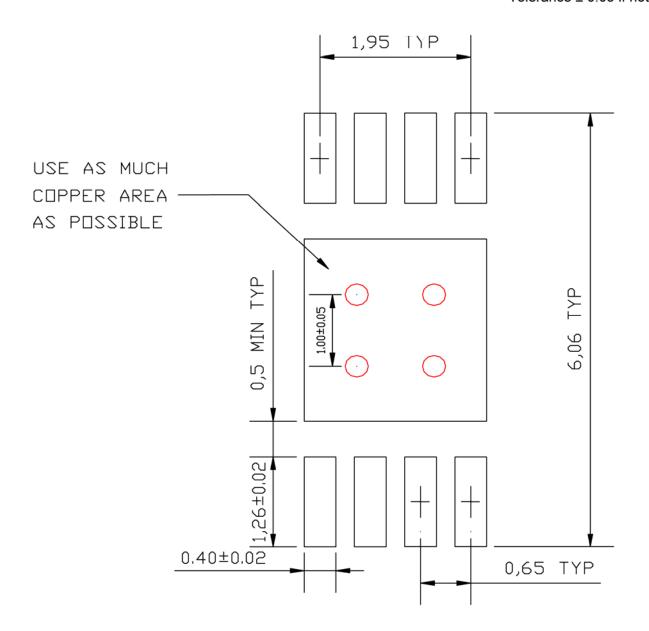
Bottom Layer

Package Information



Package Information (Continued)

LP # MSOPEP-8LD-LP-1
All units are in mm
Tolerance ± 0.05 if not noted



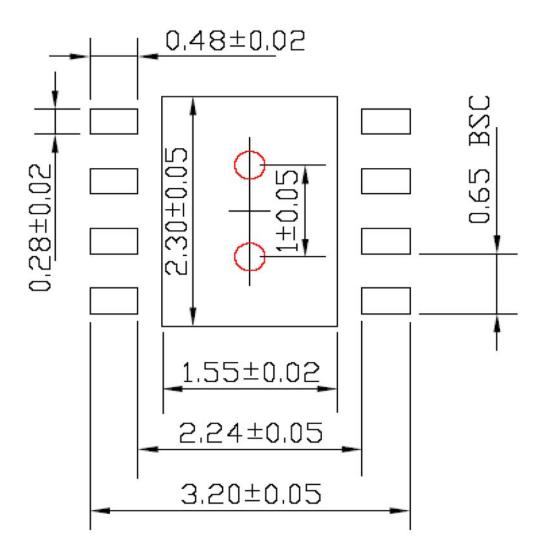
Red circle indicates Thermal Via. Size should be .300 –.350mm in diameter, 1/00mm pitch, and it should be connected to GND plane for maximum thermal performance.

8-Pin ePad MSOP (MME)

Package Information (Continued)

LP # MLF33D-8LD-LP-1

All units are in mm Tolerance ± 0.05 if not noted



Red circle indicates Thermal Via. Size should be .300 -.350mm in diameter, 1/00mm pitch, and it should be connected to GND plane for maximum thermal performance.

8-Pin ePad 3mm x 3mm MLF® (ML)

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